

### Product Change Notification / ASER-28KNNF153

# Date:

09-Nov-2021

# **Product Category:**

Interface- LIN Transceiver

# PCN Type:

Manufacturing Change

# **Notification Subject:**

CCB 3167.003 Final Notice: Qualification of a new fabrication site (Microchip - FAB 4) for a single die in selected Atmel ATSAMHxxx device families available in 32L (5x5x1mm) and 48L (7x7x1mm) VQFN packages.

## Affected CPNs:

ASER-28KNNF153\_Affected\_CPN\_11092021.pdf ASER-28KNNF153\_Affected\_CPN\_11092021.csv

## Notification Text:

PCN Status: Final Notification

PCN Type: Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of a new fabrication site (Microchip - FAB 4) for selected Atmel ATSAMHxxx device families available in 32L (5x5x1mm) and 48L (7x7x1mm) VQFN packages.

#### Pre and Post Change Summary:

Pre Change	Post Change

	Die 1	Die 2	Die 1	Die 2	
Fabrication Supplier and Location	United Microelectronics Corporation (UMC)	United Microelectronics Corporation (UMC)	United Microelectronics Corporation (UMC)	Microchip Technology Gresham Fab 4 (GRTM)	
Die Size	No ch	nange	No change		
Wafer Diameter	8 inc	ches	8 inche	2S	

### Impacts to Data Sheet:None

### Change ImpactNone

**Reason for Change:**To improve manufacturability and on-time delivery performance by qualifying Microchip Technology Gresham (Fab 4) which will remove anticipated capacity constraints of this/these product(s).

### Change Implementation Status: In Progress

### Estimated First Ship Date:November 14, 2021 (date code: 2147)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

	November 2021					
Workweek	4	4	4	4	4	
VVOLKWEEK	5	6	7	8	9	
Qual Report Availability		х				
Final PCN Issue Date		x				
Estimated Implementation Date			х			

Method to Identify Change: Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

Revision History: November 9, 2021: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

### Attachments:

PCN\_ASER-28KNNF153\_Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our PCN home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the PCN FAQ section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. ASER-28KNNF153 - CCB 3167.003 Final Notice: Qualification of a new fabrication site (Microchip - FAB 4) for a single die in selected Atmel ATSAMHxxx device families available in 32L (5x5x1mm) and 48L (7x7x1mm) VQFN packages.

Affected Catalog Part Numbers (CPN)

ATSAMHA0E14A-MZT-BVAO ATSAMHA0E15A-MZT-BVAO ATSAMHA0E16A-MZT-BVAO ATSAMHA0G14A-MZT-BVAO ATSAMHA0G15A-MZT-BVAO ATSAMHA0G16A-MZT-BVAO ATSAMHA0G17A-MZT-BVAO ATSAMHA1E14A-MBT-B510 ATSAMHA1E14A-MBT-BVAO ATSAMHA1E15A-MBT-B510 ATSAMHA1E15A-MBT-BVAO ATSAMHA1E16A-MBT-B510 ATSAMHA1E16A-MBT-BVAO ATSAMHA1G14A-MBT ATSAMHA1G14A-MBT-BVAO ATSAMHA1G15A-MBT ATSAMHA1G15A-MBT-BVAO ATSAMHA1G16A-MBT ATSAMHA1G16A-MBT-BVAO ATSAMHA1G17A-MZT-BVAO